

# MA2SD10

## Silicon epitaxial planar type

For super high speed switching

### ■ Features

- Forward current (Average)  $I_{F(AV)} = 200$  mA rectification is possible
- Low forward voltage  $V_F$
- High-density mounting is possible

### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Reverse voltage	$V_R$	20	V
Repetitive peak reverse voltage	$V_{RRM}$	20	V
Non-repetitive peak forward surge current *	$I_{FSM}$	1	A
Peak forward current	$I_{FM}$	300	mA
Forward current (Average)	$I_{F(AV)}$	200	mA
Junction temperature	$T_j$	125	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to +125	$^\circ\text{C}$

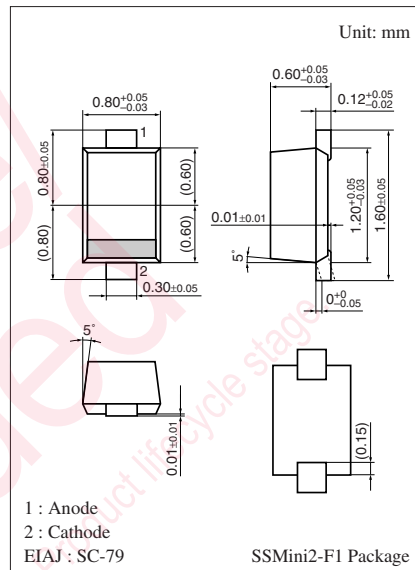
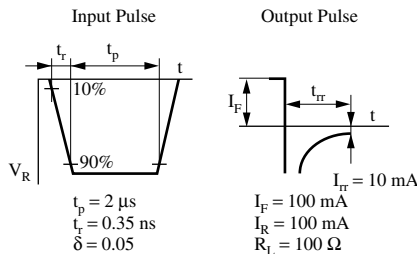
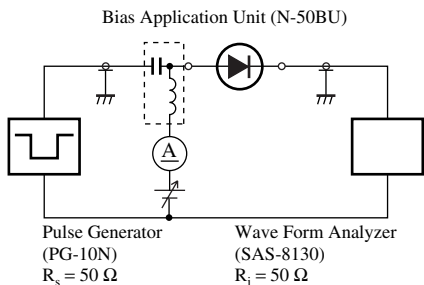
Note) \*: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)

### ■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

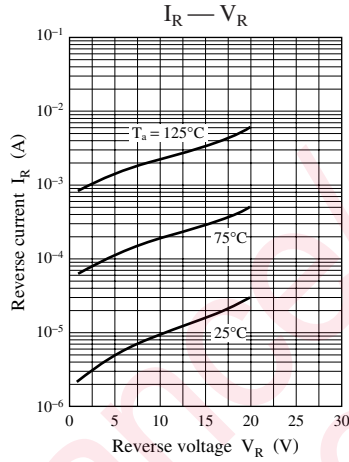
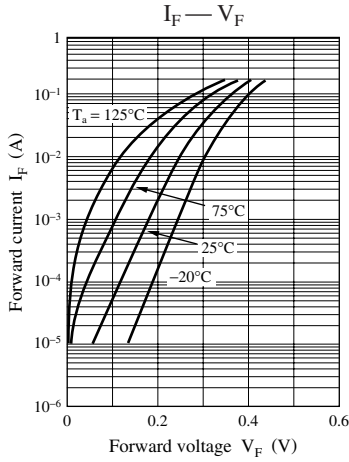
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Forward voltage	$V_{F1}$	$I_F = 5$ mA			0.27	V
	$V_{F2}$	$I_F = 100$ mA			0.40	
	$V_{F3}$	$I_F = 200$ mA			0.47	
Reverse current	$I_R$	$V_R = 10$ V			20	$\mu\text{A}$
Terminal capacitance	$C_t$	$V_R = 0$ V, $f = 1$ MHz		25		pF
Reverse recovery time *	$t_{rr}$	$I_F = I_R = 100$ mA $I_{rr} = 10$ mA, $R_L = 100 \Omega$		3		ns

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
3. Absolute frequency of input and output is 250 MHz.
4. \*:  $t_{rr}$  measurement circuit



Marking Symbol: 2L



Maintenance/Discontinued

Maintenance/Discontinued includes following four Product lifecycle stage.  
 planned maintenance type  
 maintenance type  
 planned discontinued type  
 discontinued type  
 Please visit following URL about latest information.  
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